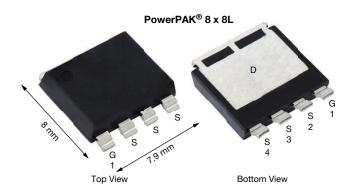


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Vishay Siliconix

# Automotive P-Channel 80 V (D-S) 175 °C MOSFET

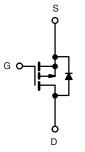


PRODUCT SUMMARY			
V <sub>DS</sub> (V)	-80		
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.0055		
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.0077		
I <sub>D</sub> (A) <sup>g</sup>	-175		
Configuration	Single		

#### **FEATURES**

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % Rq and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 8 x 8L
Lead (Pb)-free and Halogen-free	SQJQ181EL

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25$ °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	-80	V	
Gate-source voltage <sup>a</sup>		$V_{GS}$	± 20		
Continuous drain current <sup>g</sup>	$T_C = 25  ^{\circ}C$ b	- I <sub>D</sub>	-175		
	T <sub>C</sub> = 125 °C		-101		
Continuous source current (diode conduction) b, g		I <sub>S</sub>	-317	Α	
Pulsed drain current c, g		I <sub>DM</sub>	-619		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	-78		
Single pulse avalanche energy	L = 0.1 IIII	E <sub>AS</sub>	305	mJ	
Maximum power dissipation c, g	T <sub>C</sub> = 25 °C	P <sub>D</sub>	348	W	
	T <sub>C</sub> = 125 °C		116		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperature) d, e			260	O	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount e	R <sub>thJA</sub>	42	°C/W
Junction-to-case (drain) <sup>f</sup>		$R_{thJC}$	0.43	C/VV

#### **Notes**

- a. Not intended for continuous use with positive gate voltage > 5.0 V
- b. Package limited
- When mounted on 1" square PCB (FR4 material)
- See solder profile (<a href="https://www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). For PowerPAK SO-8L, the end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
  Pulse test; pulse width \( \leq 300 \) µs, duty cycle \( \leq 2 \) %

- f. Using thermal characterization methods based on JESD51-14
   g. Values based on R<sub>thJC</sub> and T<sub>C</sub> of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system



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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	1					L		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0$ , $I_D = -250 \mu A$		-80	-	-	,,	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = -250 μA	-1.5	-2.0	-2.5	V	
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zero gate voltage drain current		$V_{GS} = 0 V$	V <sub>GS</sub> = 0 V V <sub>DS</sub> = -80 V -		-	-1		
	I <sub>DSS</sub>		V <sub>DS</sub> = -80 V, T <sub>J</sub> = 125 °C	-	-	-50	μA	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = -80 V, T <sub>J</sub> = 175 °C	-	-	-150		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = -10 V	$V_{DS} \ge -5 \text{ V}$	-30	-	-	Α	
Drain-source on-state resistance <sup>a</sup>	, ,	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A	-	0.0046	0.0055	-	
		V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A, T <sub>J</sub> = 125 °C	-	-	0.0098		
	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A, T <sub>J</sub> = 175 °C	-	-	0.0120	Ω	
			I <sub>D</sub> = -8 A	-	0.0063	0.0075	1	
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub> =	: -15 V, I <sub>D</sub> = -30 A	-	110	-	S	
Dynamic <sup>b</sup>	1	•				I.		
Input capacitance	C <sub>iss</sub>		V <sub>DS</sub> = -25 V, f = 1 MHz	-	10 343	14 481	pF	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	4135	4789		
Reverse transfer capacitance	C <sub>rss</sub>	7			196	275	1	
Total gate charge c	$Q_{g}$			-	153	230		
Gate-source charge c	$Q_{gs}$	V <sub>GS</sub> = -10 V	$V_{GS} = -10 \text{ V}$ $V_{DS} = -40 \text{ V}, I_{D} = -50 \text{ A}$		39	-	nC	
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>	1		-	20	-	1	
Gate resistance	R <sub>g</sub>	f = 1 MHz		0.8	1.8	3.2	Ω	
Turn-on delay time c	t <sub>d(on)</sub>				19	29	ns	
Rise time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = -40 \text{ V, } R_L = 4 \Omega,$ $I_D \cong -10 \text{ A, } V_{GEN} = -10 \text{ V, } R_g = 1 \Omega$		-	11	17		
Turn-off delay time c	t <sub>d(off)</sub>			-	80	120		
Fall time <sup>c</sup>	t <sub>f</sub>			-	21	32		
Source-Drain Diode Ratings and Chara	acteristics b	-						
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	-619	Α	
Forward voltage	$V_{SD}$	I <sub>F</sub> = -10 A, V <sub>GS</sub> = 0 V		-	-0.76	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = -40 A, di/dt = 100 A/μs		-	105	210	ns	
Body diode reverse recovery charge	$Q_{rr}$			-	205	410	nC	
Reverse recovery fall time	ta			-	56	-	ns	
Reverse recovery rise time	t <sub>b</sub>			-	52	-		
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-3.1	-	Α	

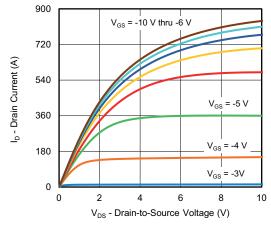
### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

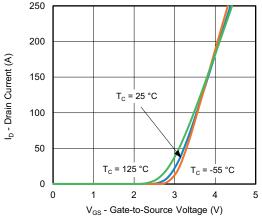
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



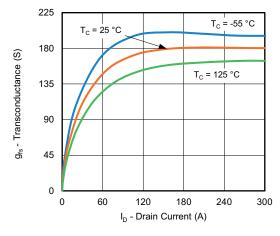
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



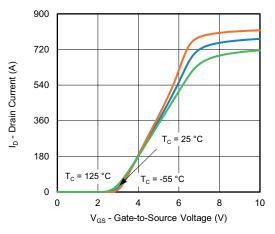
### **Output Characteristics**



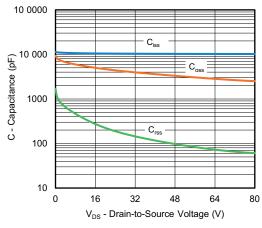
Transfer Characteristics



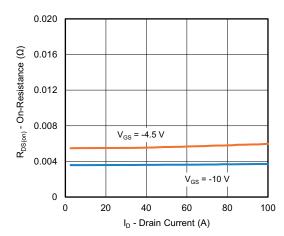
Transconductance



**Transfer Characteristics** 



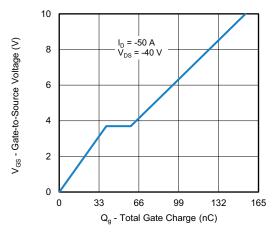
Capacitance



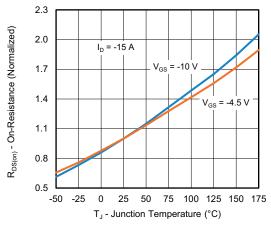
On-Resistance vs. Drain Current



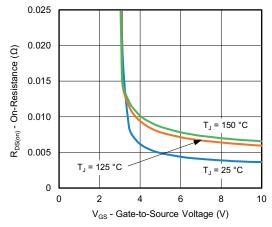
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



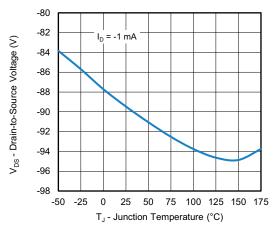
#### **Gate Charge**



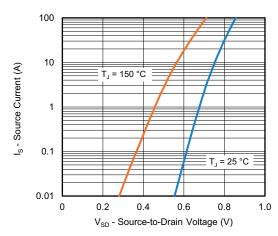
On-Resistance vs. Junction Temperature



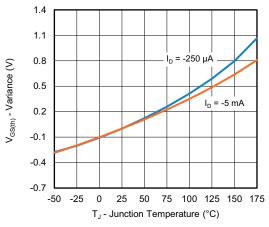
On-Resistance vs. Gate-to-Source Voltage



**Drain-Source Breakdown vs. Junction Temperature** 



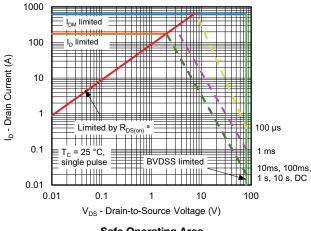
**Source Drain Diode Forward Voltage** 



**Threshold Voltage** 



### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

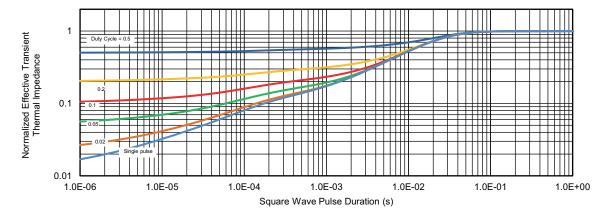


Safe Operating Area

#### Note

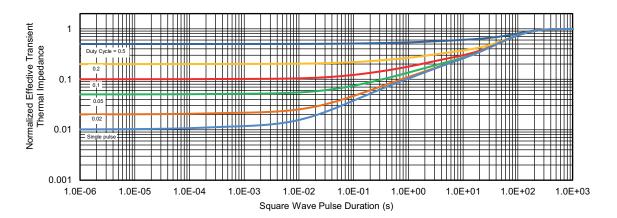
a.  $V_{GS} > \mbox{minimum} \ V_{GS}$  at which  $R_{DS(on)}$  is specified

## THERMAL RATINGS (T<sub>C</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case





#### Normalized Thermal Transient Impedance, Junction-to-Ambient

#### Note

- · The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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